

FEATURES

- 3.3 Volt Operation
- 8-Bit Resolution
- Small 20 Pin SOIC, PDIP & SSOP Packages
- DNL = $\pm 1/2$ LSB, INL = ± 1 LSB (typ)
- Internal S/H Function
- V_{IN} DC Range: 0 V to V_{DD}
- V_{REF} DC Range: 1 V to V_{DD}
- Low Power: 20 mW typ. (excluding reference)

- Latch-Up Free
- Monotonic: No Missing Codes

APPLICATIONS

- Digital Radio
- Cellular Telephones
- CCD's and Scanners
- Hand Held and Battery Powered Data Acquisition

GENERAL DESCRIPTION

The MP87L75 is an 8-bit Analog-to-Digital Converter in a small 20 pin SOIC package that operates at 3.3 V. Designed using an advanced CMOS process, this part offers excellent performance, low power consumption and latch-up free operation.

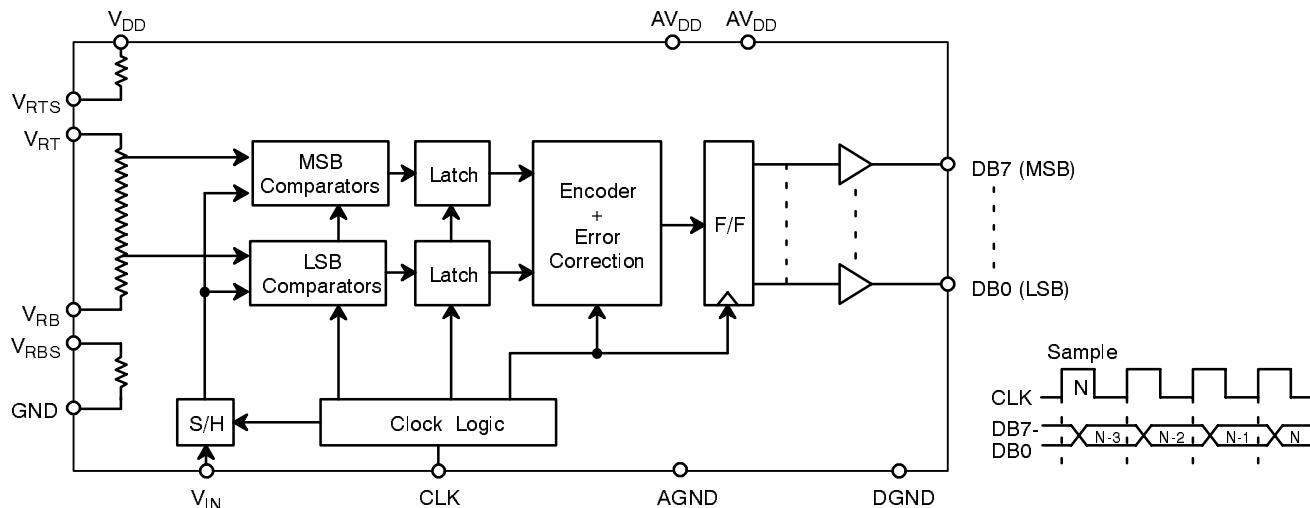
This device uses a two-step flash architecture to maintain low power consumption at high conversion rates. The input circuitry of the MP87L75 includes an on-chip S/H function and allows the user to digitize analog input signals between GND and V_{DD} . Careful design and chip layout have achieved a low analog input capacitance. This reduces "kickback" and eases the requirements of the buffer/amplifier used to drive the MP87L75.

The designer can choose the internally generated reference voltages by connecting V_{RB} to V_{RBS} and V_{RT} to V_{RTS} , or provide external reference voltages to the V_{RB} and V_{RT} pins. The internal reference generates 0.4 V at V_{RB} and 1.72 V at V_{RT} . Providing external reference voltages allows easy interface to any input signal range between GND and V_{DD} . This also allows the system to adjust these voltages to cancel zero scale and full scale errors, or to change the input range as needed.

The device operates from a single +3.3 V supply $\pm 10\%$. Power consumption is 20 mW at $F_s = 10$ MHz.

Specified for operation over the commercial / industrial (-40 to +85°C) temperature range, the MP87L75 is available in Plastic dual-in-line (PDIP), Surface Mount (SOIC), and Shrunk small outline (SSOP) packages.

SIMPLIFIED BLOCK AND TIMING DIAGRAM

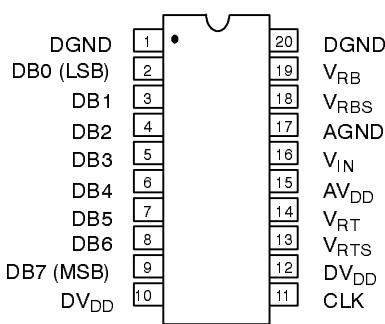


ORDERING INFORMATION

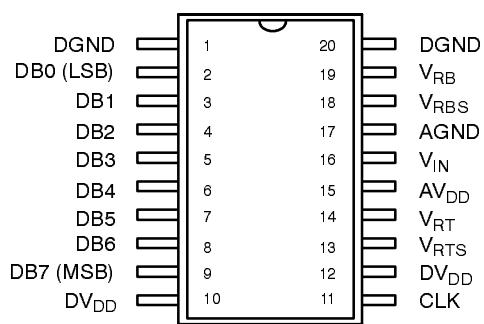
| Package Type | Temperature Range | Part No. | DNL (LSB) | INL (LSB) |
|--------------|-------------------|-----------|-----------|-----------|
| SOIC | -40 to +85°C | MP87L75AS | ±1/2 | 1 1/2 |
| SSOP | -40 to +85°C | MP87L75AQ | ±1/2 | 1 1/2 |
| PDIP | -40 to +85°C | MP87L75AN | ±1/2 | 1 1/2 |

PIN CONFIGURATIONS

See Packaging Section for
Package Dimensions



20 Pin PDIP (0.300")



20 Pin SOIC (Jedec, 0.300") – S20

PIN OUT DEFINITIONS

| PIN NO. | NAME | DESCRIPTION |
|---------|------------------|-------------------------|
| 1 | DGND | Digital Ground |
| 2 | DB0 | Data Output Bit 0 (LSB) |
| 3 | DB1 | Data Output Bit 1 |
| 4 | DB2 | Data Output Bit 2 |
| 5 | DB3 | Data Output Bit 3 |
| 6 | DB4 | Data Output Bit 4 |
| 7 | DB5 | Data Output Bit 5 |
| 8 | DB6 | Data Output Bit 6 |
| 9 | DB7 | Data Output Bit 7 (MSB) |
| 10 | DV _{DD} | Digital Power Supply |

| PIN NO. | NAME | DESCRIPTION |
|---------|------------------|-----------------------------|
| 11 | CLK | Sample Clock |
| 12 | DV _{DD} | Digital Power Supply |
| 13 | V _{RTS} | Internal Top Ladder Bias |
| 14 | V _{RT} | Top Reference |
| 15 | AV _{DD} | Analog Power Supply |
| 16 | V _{IN} | Analog Input |
| 17 | AGND | Analog Ground |
| 18 | V _{RBS} | Internal Bottom Ladder Bias |
| 19 | V _{RB} | Bottom Reference |
| 20 | DGND | Digital Ground |

ELECTRICAL CHARACTERISTICS TABLE

Unless Otherwise Specified: $AV_{DD} = DV_{DD} = 3.3\text{ V}$, $FS = 6\text{ MHz}$ (50% Duty Cycle),
 $V_{RT} = 2.5\text{ V}$, $V_{RB} = 0.5\text{ V}$, $T_A = 25^\circ\text{C}$

| Parameter | Symbol | Min | 25°C Typ | Max | Units | Test Conditions/Comments |
|---|--------------|----------|-------------|-----------|-----------------------|--|
| KEY FEATURES | | | | | | |
| Resolution | | 8 | | | Bits | |
| Maximum Sampling Rate | FS | 6 | 10 | | MHz | |
| ACCURACY (A Grade)¹ | | | | | | |
| Differential Non-Linearity | DNL | | | $\pm 1/2$ | LSB | |
| Integral Non-Linearity | INL | | | $1 1/2$ | LSB | Best Fit Line (Min INL – Max INL)/2 |
| REFERENCE VOLTAGES | | | | | | |
| Differential Ref. Voltage ³ | V_{REF} | 1.0 | | AV_{DD} | V | |
| Ladder Resistance | R_L | | 350 | | Ω | |
| Ladder Temp. Coefficient | R_{TCO} | | 2000 | | ppm/ $^\circ\text{C}$ | |
| Self Bias 1 | | | | | | |
| Short V_{RB} and V_{RBS} | V_{RB} | | 0.4 | | V | |
| Short V_{RT} and V_{RTS} | V_{RT-VRB} | | 1.32 | | V | |
| Self Bias 2 | | | | | | |
| $V_{RB} = \text{AGND}$, | V_{RT} | | 1.52 | | V | |
| Short V_{RT} and V_{RTS} | | | | | | |
| ANALOG INPUT | | | | | | |
| Input Bandwidth (-1 dB) ⁴ | BW | | 5 | | MHz | |
| Input Voltage Range | V_{IN} | V_{RB} | | V_{RT} | V | |
| Input Capacitance ⁵ | C_{IN} | | 16 | | pF | |
| Aperture Delay | t_{AP} | | 30 | | ns | |
| DIGITAL INPUTS | | | | | | |
| Logical "1" Voltage | V_{IH} | 2.5 | | 0.5 | V | |
| Logical "0" Voltage | V_{IL} | | | | V | |
| DC Leakage Currents ⁶ | I_{IN} | | | | μA | |
| CLK | | | 5 | | μA | |
| Input Capacitance | | | 5 | | pF | |
| Clock Timing (See Figure 1.) ⁷ | | | | | | |
| Clock Period | 1/FS | | 100 | | ns | |
| High Pulse Width | t_{PWH} | | 50 | | ns | |
| Low Pulse Width | t_{PWL} | | 50 | | ns | |
| DIGITAL OUTPUTS | | | | | | |
| Logical "1" Voltage | V_{OH} | 2.5 | | 0.5 | V | $C_{OUT}=15\text{ pF}$ |
| Logical "0" Voltage | V_{OL} | | | | V | $I_{LOAD} = 1\text{ mA}$ |
| Data Valid Delay | t_{DL} | | 30 | | ns | $I_{LOAD} = 1\text{ mA}$ |

ELECTRICAL CHARACTERISTICS TABLE (CONT'D)

| Description | Symbol | Min | 25°C Typ | Max | Units | Conditions |
|--|----------------------|-----|-------------|-----------|---------|-------------------------------|
| POWER SUPPLIES | | | | | | |
| Operating Voltage (AV_{DD} , DV_{DD}) Current | V_{DD} I_{DD} | 3 | 3.3 6 | 3.6 12 | V mA | Does not include ref. current |

Notes:

- ¹ Tester measures code transitions by dithering the voltage of the analog input (V_{IN}). The difference between the measured and the ideal code width ($V_{REF}/256$) is the DNL error (Figure 2.). The INL error is the maximum distance (in LSBs) from the best fit line to any transition voltage (Figure 3.). Accuracy is a function of the sampling rate (FS).
- ² Guaranteed. Not tested.
- ³ Specified values guarantee functionality. Refer to other parameters for accuracy.
- ⁴ -1 dB bandwidth is a measure of performance of the A/D input stage (S/H + amplifier). Refer to other parameters for accuracy within the specified bandwidth.
- ⁵ See V_{IN} input equivalent circuit (Figure 4.). Switched capacitor analog input requires driver with low output resistance.
- ⁶ All inputs have diodes to V_{DD} and GND. Input DC currents will not exceed specified limits for any input voltage between GND and V_{DD} .
- ⁷ t_R , t_F should be limited to >5 ns for best results.
- ⁸ AGND & DGND pins are connected through the silicon substrate. Connect together at the package and to the analog ground plane.

Specifications are subject to change without notice

ABSOLUTE MAXIMUM RATINGS (TA = +25°C unless otherwise noted)^{1, 2, 3}

| | | | |
|---------------------------|-----------------------------|---|---------------|
| V_{DD} to GND | 5.5 V | Storage Temperature | -65 to +150°C |
| V_{RT} & V_{RB} | V_{DD} +0.5 to GND -0.5 V | Lead Temperature (Soldering 10 seconds) | +300°C |
| V_{IN} | V_{DD} +0.5 to GND -0.5 V | Package Power Dissipation Rating @ 75°C | |
| All Inputs | V_{DD} +0.5 to GND -0.5 V | SOIC, SSOP, PDIP | 700 mW |
| All Outputs | V_{DD} +0.5 to GND -0.5 V | Derates above 75°C | 9mW/°C |

Notes:

- ¹ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.
- ² Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies. All inputs have protection diodes which will protect the device from short transients outside the supplies of less than 100mA for less than 100μs.
- ³ V_{DD} refers to AV_{DD} and DV_{DD} . GND refers to AGND and DGND.

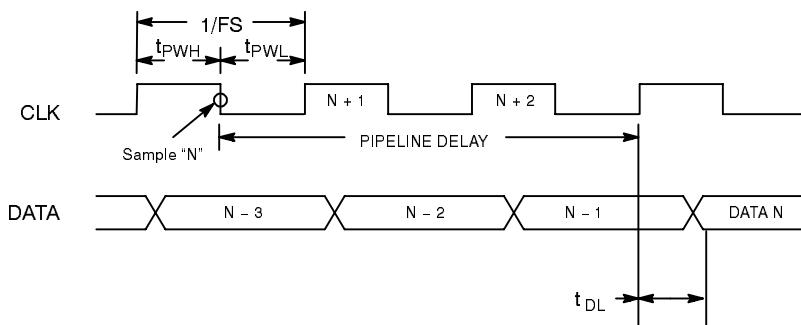


Figure 1. MP87L75 Timing Diagram

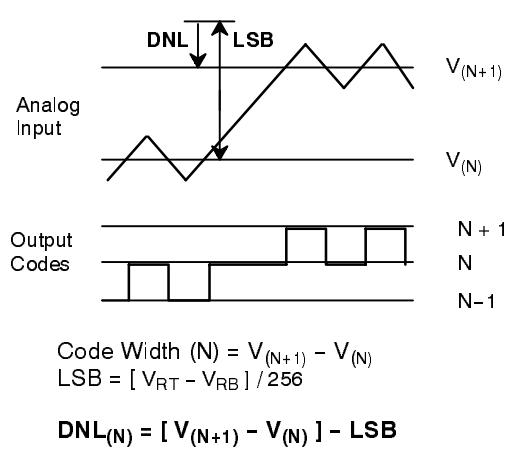


Figure 2. DNL Measurement

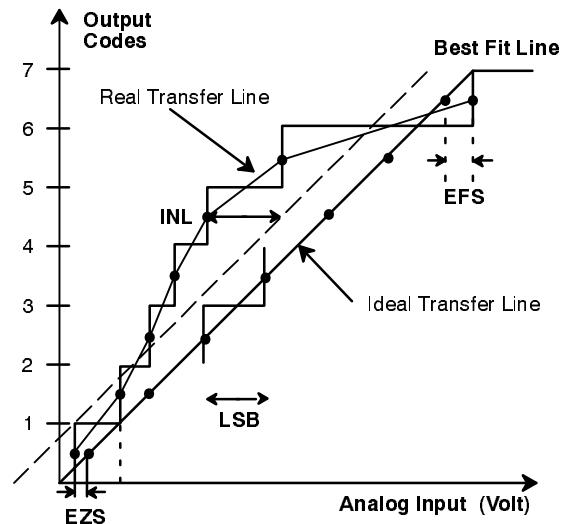


Figure 3. INL Error Calculation

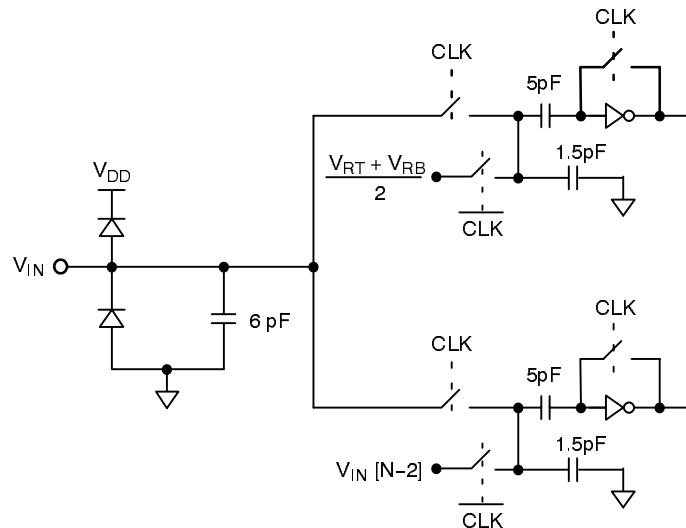


Figure 4. Equivalent Input Circuit

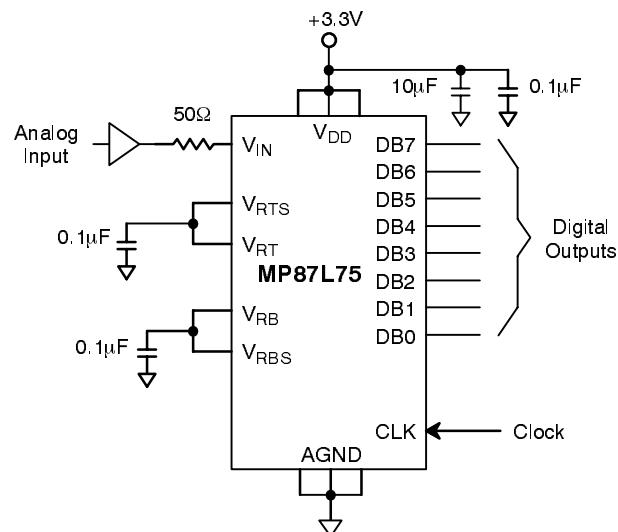


Figure 5. Typical Circuit Connections

APPLICATION NOTES

Signals should not exceed AV_{DD} or $DV_{DD} + 0.5V$ or go below AV_{DD} or $DV_{DD} - 0.5V$. All pins have internal protection diodes that will protect them from short transients ($<100\mu s$) outside the supply range.

AGND and DGND pins are connected internally through the P-substrate. DC voltage differences between these pins will cause undesirable internal substrate currents.

The power supply (AV_{DD}) and reference voltage (V_{RT} & V_{RB}) pins should be decoupled with $0.1\mu F$ and $10\mu F$ capacitors to AGND, placed as close to the chip as possible.

The digital outputs should not drive long wires or buses. The

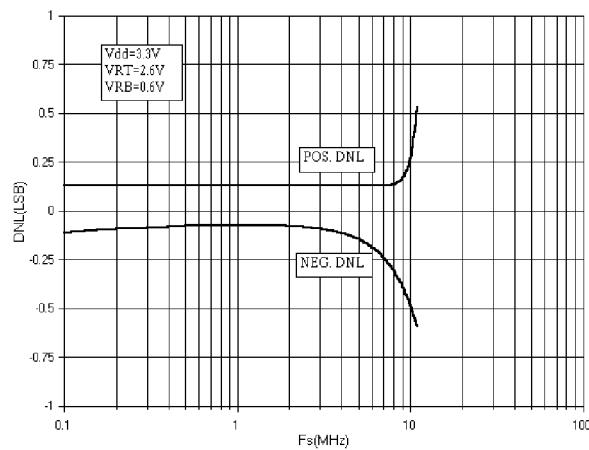
capacitive coupling and reflections will contribute noise to the conversion.

It is possible for the data valid delay (t_{DL}) to be equal to or greater than the high pulse width of the sampling clock (t_{PWH}). See *Figure 1*. This can cause timing related errors. For sample rates above 8 MSPS use only the rising edge of the sample clock (CLK) to latch data from the MP87L75 to other parts of the system.

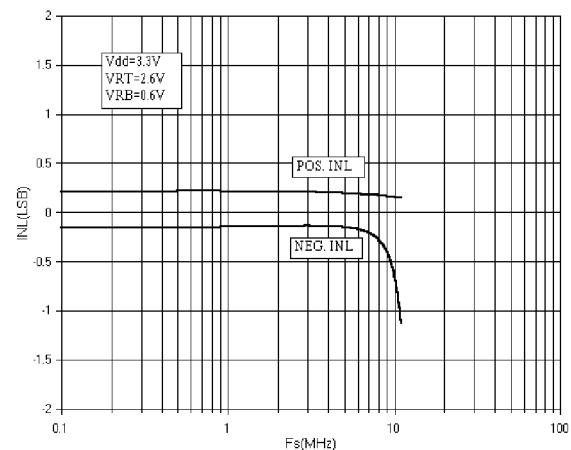
The reference can be biased internally by shorting V_{RT} to V_{RTS} and V_{RB} to V_{RBS} . This will generate 0.36 V at V_{RB} and 1.56 V at V_{RT} (see *Figure 5*).

If the internal reference pins V_{RTS} and/or V_{RBS} are not used they should be left unconnected.

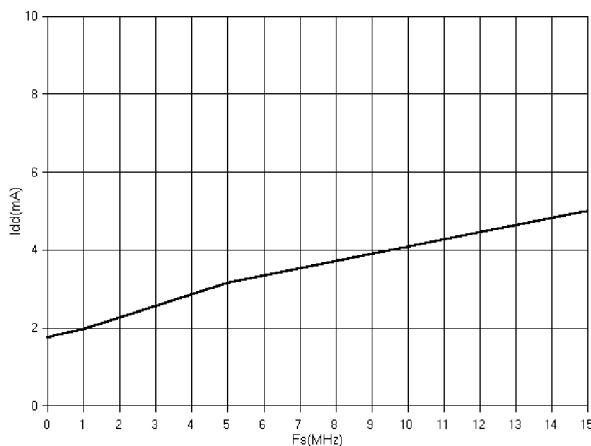
PERFORMANCE CHARACTERISTICS



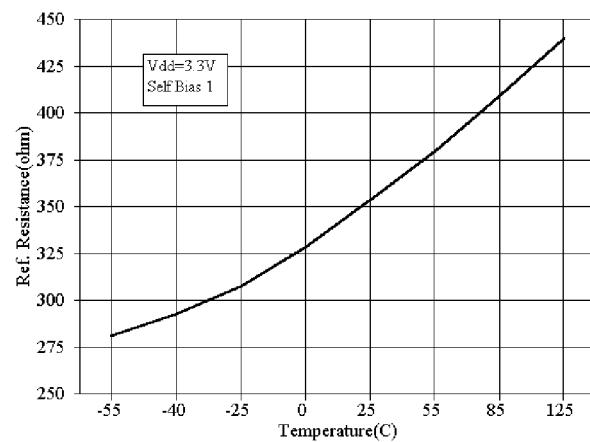
Graph 1. DNL vs. Sampling Frequency



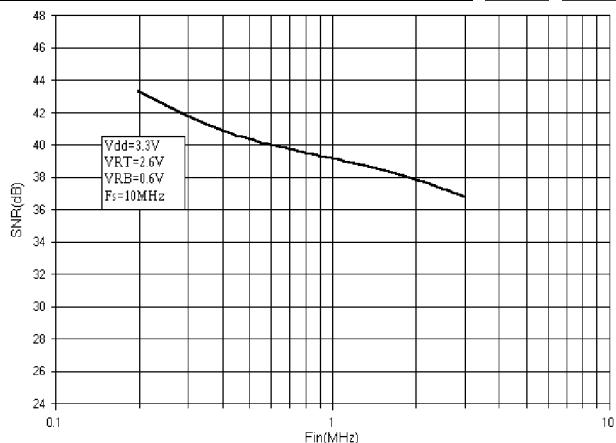
Graph 2. INL vs. Sampling Frequency



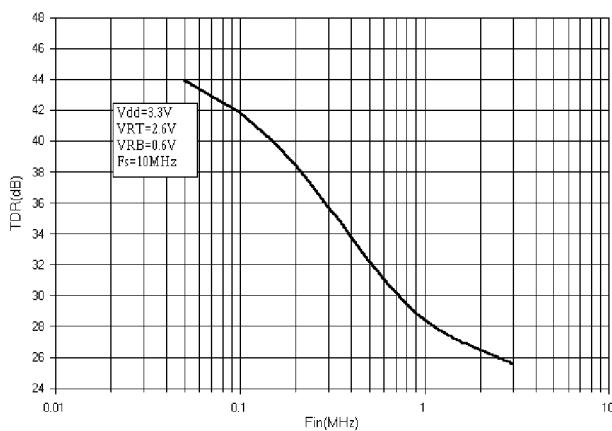
Graph 3. Supply Current vs. Sampling Frequency



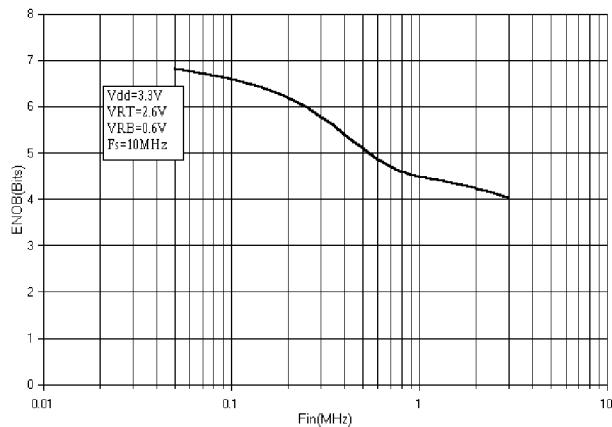
Graph 4. Reference Resistance vs. Temperature



Graph 5. SNR vs. Input Frequency



Graph 6. SINAD vs. Input Frequency



Graph 7. ENOB vs. Input Frequency